

Upcoming: August 31–5, 14th Intl. Symposium on Chemical Vapor Deposition/EuroCVD Eleven, Endorsed.

To list an event in the Calendar, contact J. Meiksin, Materials Research Society, 9800 McKnight Road, Pittsburgh, PA 15237-6006; 412-367-3004 ext. 522; fax 412-367-4373.

MRS, A-MRS, C-MRS, E-MRS, MRS-I, MRS-J, MRS-K, MRS-R, MRS-T, M-MRS, or IUMRS at the end of an entry indicates sponsorship or co-sponsorship of an event by the International Union of Materials Research Societies or one of its adhering bodies. "Endorsed" identifies events endorsed by MRS.

▼ identifies a new or revised entry this month.

See the May 1997 MRS BULLETIN for July 1997 Calendar entries.

AUGUST 1997

3–8 8th European Conf. on Diamond, Diamond-Like, and Related Materials, and 4th Intl. Conf. on Applications of Diamond Films and Related Materials, Edinburgh, Scotland. Diamond 1997 Conf. Secretariat, 22 Plas Taliesin, Portway Village Marina, Penarth CF64 1TN, Wales, UK; 44-1222-700053; fax 44-1222-700665; e-mail enquiries@global-meeting.co.uk; http://www.global-meeting.co.uk.

3–8 Thermal Spray Processing of Nanoscale Materials, Davos, Switzerland. Engineering Foundation, 345 E. 47th St., New York, NY 10017; 212-705-7836; fax 212-705-7441; e-mail engfnd@aol.com; http://www.engfnd.org.

10–14 Annual Meeting of the Microscopy Society of America, Microbeam Analysis Society, and The Histochemical Society, Cleveland, OH. Microscopy Society of America Business Office, 800-538-3672; fax 508-563-1211; e-mail BusinessOffice@MSA.microscopy.com; http://www.msa.microscopy.com.

11–21 NATO Advanced Study Inst. on Nanostructured Materials: Science and Technology, St. Petersburg, Russia. G-M. Chow, U.S. Naval Research Lab., Materials Science and Technology Div., Code 6323, Washington, DC 20375; 202-767-3433; fax 202-767-2623; e-mail gmchow@anvil.nrl.navy.mil.

15–16 ▼ Crystal Defects, Interfaces, Fracture and Other Topics in the Research Areas of H.G.F. Wilsdorf and D. Kuhlmann-Wilsdorf, Charlottesville, VA. Dept. of Materials Science & Engineering, University of Virginia, School of Engineering and Applied Science, Charlottesville, VA 22903-2442; 804-982-5643; fax 804-982-5660; e-mail waj@virginia.edu.

17–20 Intl. Symposium on Materials Solutions for Environmental Problems, Sudbury, Canada. H. Mostaghaci, Advanced Materials and Plastics Branch, Industry Canada, 235 Queen St., Ottawa, Ontario K1A 0H5, Canada; 613-954-5012; fax 613-952-4209; e-mail mostaghaci.hamid@ic.gc.ca.

17–21 1997 Intl. Conf. on Neutron Scattering, Toronto, Canada. P.H. Green, Solid State Div., Oak Ridge National Lab., P.O. Box 2008, Oak Ridge, TN 37831-6033; 423-576-1864; fax 423-574-4143; e-mail phg@ornl.gov; http://www.physics.utoronto.ca/icns/icns.html.

17–22 ▼ Gordon Research Conf.—Materials Processes Far from Equilibrium, Meriden, NH. Gordon Research Ctr., Univ. of Rhode Island, P.O. Box 984, West Kingston, RI 02892-0984; 401-783-4011; 401-783-7644; e-mail grc@grcmail.grc.uri.edu.

19–21 ▼ Intl. Conf. on Virtual Instrumentation, Austin, TX. J. Rodriguez, National Instruments, 6504 Bridge Point Pkwy., Austin, TX 78730-5039; 800-258-7022; fax (512) 794-8411; e-mail niweek@natinst.com; http://www.natinst.com.

24–29 9th Intl. Meeting on Ferroelectricity, Seoul, Korea. IMF-9 Secretariat, INTERCOM Convention Service, Inc., 4Fl., Jisung Bldg., #645-20, Yoksam 1-dong, Kangnam-ku, Seoul, 135-081, Korea; 82-2-568-3208; fax 82-2-565-2434; e-mail intercom@soback.kornet.nm.kr.

25–28 16th General Conf. on the Condensed Matter Division of the European Physical Society, Leuven, Belgium. The Secretary-General, 16th CMD-General Conf., Dept. Natuurkunde K. U. Leuven, Celestijnenlaan 200 D, B-3001 Leuven, Belgium; 32-16-327175; fax 32-16-327983.

25–29 8th Intl. Conf. on II–VI Compounds, Grenoble, France. L.S. Dang, II–VI Conf. Secretariat, Lab. de Spectrométrie Physique, Univ. J. Fourier, Grenoble, B.P. 87, 38402 St. Martin d'Hères Cedex, France; fax 33-0476-514544; e-mail lesidang@spectro.grenet.fr; http://www.spectro.grenet.fr/~icc_2_6.

26–29 16th Intl. Conf. on Thermoelectrics, Dresden, Germany. J. Schumann, ICT '97 Technical Program Chairman, Inst. of Solid State and Materials Research, Helmholtzstr. 20, D-01069 Dresden, Germany; 49-351-4659643; fax 49-351-4659780; e-mail ict97@ifw-dresden.de.

27–29 4th Intl. Conf. on Computational Modeling of Free and Moving Boundary Problems, Ghent, Belgium. S. Owen, Moving Boundaries 97 Conf. Secretariat, Wessex Inst. of Technology, Ashurst Lodge, Ashurst, Southampton SO40 7AA, UK; 44-1-703-293223; fax 44-1-703-292853; e-mail sue@wessex.ac.uk; http://www.wessex.ac.uk.

28–2 Advanced Quantum Field Theory, La Londe les Maures, France. J. Hendekovic, European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-388-767135; fax 33-388-366987; e-mail euresco@esf.org; http://www.esf.org/euresco.

31–5 14th Intl. Symposium on Chemical Vapor Deposition/EuroCVD Eleven, Paris, France. Electrochemical Society; 609-737-1902; fax 609-737-2743; e-mail ecs@electrochem.org; http://www.electrochem.org. Endorsed.

31–5 Intl. Conf. on Silicon Carbide, III-Nitrides, and Related Materials, Stockholm, Sweden. Stockholm Convention Bureau, ICSCIII—N'97, P.O. Box 6911, S-102 39 Stockholm, Sweden.

SEPTEMBER 1997

1–5 Intl. Conf. on Crystallographic Texture and Mechanical Anisotropy, Hyannis, MA. Engineering Foundation, 345 E. 47th St., New York, NY 10017; 212-705-7836; fax 212-705-7441; e-mail engfnd@aol.com; http://www.engfnd.org.

1–12 NATO Advanced Study Inst. on Gap Symmetry and Fluctuations in High-T_c Superconductors, Corsè, France. D. Pavuna; 41-21-6933301; fax 41-21-6934666; e-mail pavuna@eldp.epfl.ch.

4–7 5th Nepcon Thailand Intl. Electronics Manufacturing Technology Trade Exhibition and Conf., Bangkok, Thailand. R. Suksirivong, Reed Tradex Co., Reed Tradex Bldg., 323 Bond St., Muang Thong Thani, Nonthaburi 11120, Thailand; 66-2-503-2199; fax 66-2-503-4963.

5–10 Molecular Liquids: Orientational Order and Dynamics in Liquids and Glasses, Crete, Greece. J. Hendekovic, European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-388-767135; fax 33-388-366987; e-mail euresco@esf.org; http://www.esf.org/euresco.

6–11 Chemistry and Physics of Multifunctional Materials: Fullerenes in Context, Espinho, Portugal. J. Hendekovic, European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-388-767135; fax 33-388-366987; e-mail euresco@esf.org; http://www.esf.org/euresco.

7–10 6th Intl. Conf. on Ceramic Processing, Santa Barbara, CA. F.F. Lange, MRL, ENG II, Univ. of California at Santa Barbara, Santa Barbara, CA 93106; e-mail ceramics@mrl.ucsb.edu.

7–10 7th Intl. Conf. on Defect Recognition and Image Processing in Semiconductors, Berlin, Germany. DRIP VII Secretary, Ferdinand-Braun-Inst., Rudower Chaussee 5, D-12489 Berlin, Germany; 49-30-63922642; e-mail DRIPVII-fbh-ikz@fbh.fht-berlin.de.

7–11 24th Intl. Symposium on Compound Semiconductors, San Diego, CA. M. Melloch, Purdue Univ., 1285 Electrical Engineering Bldg., W. Lafayette, IN 47907-1285; 317-494-3528; fax 317-494-6441; e-mail melloch@ecn.purdue.edu.

7–20 Summer School on Superconductivity in Networks and Mesoscopic Structures, Siena, Italy. C. Giovannella, Dipartimento di Fisica, Univ. di Roma "Tor Vergata," Via della Ricerca Scientifica 1, I-00133 Rome, Italy; 39-6-72594524; fax 39-6-2023507; e-mail supnet@roma2.infn.it; http://wwwas.roma2.infn.it.

8–10 11th Intl. Conf. on Surface Modification Techniques, Paris, France. ASM Intl., Member Services Center, Materials Park, OH 44073-0002; 216-338-5151; fax 216-338-4634; e-mail memserv@po.asm-intl.org.

13–15 3rd Okinaga Symposium on Materials Science and Engineering Serving Society, Makuhari, Chiba, Japan. S. Sōmiya, Teikyō Univ. of Science and Technology, 3-4-7 Seijo, Setagaya, Tokyo 157, Japan; 81-554-634411; fax 81-3-3415-6619.

13–18 Quantum Optics, Castelvecchio Pascoli, Italy. J. Hendekovic, European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-388-767135; fax 33-388-366987; e-mail euresco@esf.org; http://www.esf.org/euresco.

14–18 ASM/TMS Materials Week and Materials Exposition; 17th ASM Heat Treating Society Conf.; and ASM Thermal Spray Society and DVS (German Welding Society) United Thermal Spray Conf.; Indianapolis, IN. ASM Intl., Member Services Center, Materials Park, OH 44073-0002; 216-338-5151; fax 216-338-4634; e-mail memserv@po.asm-intl.org.

14–18 Conf. on Spectroscopies in Novel Superconductors, Cape Cod, MA. J. Pumphrey, Conf. Secretary, The Barnett Inst., Northeastern Univ., Boston, MA 02115; 617-373-2868; fax 617-373-2855.

14–19 Radiation Effects in Insulators—9, Knoxville, TN. REI-9 Secretariat, c/o J. Johnson, 100 Estabrook Hall, Univ. of Tennessee, Knoxville, TN 37996-2350; 423-974-0816; 423-974-4995; e-mail jewell@utk.edu.

15–17 Intl. Conf. on Fine Powder Processing, State College, PA. Particulate Materials Center, 147 Research Bldg. West, The Pennsylvania State Univ., University Park, PA 16802-6809; 814-863-6156; fax 814-863-9704; e-mail rgc5@psu.edu; http://pmcenter.cerse.psu.edu.

15–18 ▼ 20th Durham Conf. on X-Ray Analysis, Durham, UK. Philips Analytical X-Ray, York St., Cambridge CB1 2QU, UK; 44-0-1223-374411; e-mail ukzsmsl@ukccmail.snads.philips.nl.

15–19 2nd Yugoslav Conf. on Advanced Materials, Herceg Novi, Yugoslavia. P. Živanović, Conf. Secretary, Inst. of Technical Sciences of the Serbian Academy of Sciences and Arts, Knez Mihailova 35/IV, P.O. Box 745, 11000 Belgrade, Yugoslavia; 381-11-185437; fax 381-11-185263.

16-18 4th IUMRS Intl. Conf., Chiba, Japan. Y. Masahiro, Materials and Structures Lab., Tokyo Inst. of Technology, 4259 Nagatsuta, Midori, Yokohama 226, Japan; 81-45-924-5323; fax 81-45-924-5358; e-mail iumrs1@riem.titech.ac.jp. **IUMRS.**

17-18 ▼ Intl. Activated Carbon Conf., *Pittsburgh, PA.* H.G. Nowicki, Professional Analytical and Consulting Services, Inc., 409 Meade Dr., Coraopolis, PA 15108; 412-457-6576; fax 412-457-1214; e-mail hnpacs@aol.com; http://members.aol.com/hnpacs/pacs/htm.

17-19 ▼ Photomask Technology and Management, *Santa Clara, CA.* SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; http://www.spie.org.

20-25 Very High Resolution Spectroscopy with Photoelectrons: Basic Processes and Applications, *Emmetten, Switzerland.* J. Hendekovic, European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-388-767135; fax 33-388-366987; e-mail euresco@esf.org; http://www.esf.org/euresco.

21-24 Midwestern Mechanics Conf., *Rapid City, SD.* L. Kjerengtroen, S. Dakota School of Mines and Technology, Dept. of Mechanical Engineering, Rapid City, SD 57701; 605-394-2409; fax 605-395-2405; e-mail lkjereng@msmailgw.sdsmt.

21-25 5th Intl. Symposium on Advanced Materials, *Islamabad, Pakistan.* Secretariat, A.Q. Khan Research Laboratories, P.O. Box 905, Rawalpindi, Pakistan; 92-51-450734; fax 92-51-452487; e-mail 100074.172@compuserve.com.

21-25 ▼ EUROPTO® Series—Satellite Remote Sensing IV, *London, UK.* SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; http://www.spie.org.

21-26 2nd Intl. Symposium on Structural Intermetallics, *Champion, PA.* B. Kamperman, The Minerals, Metals & Materials Society, 420 Commonwealth Dr., Warrendale, PA 15086; 412-776-9000, ext. 234; fax 412-776-3770; e-mail kamperman@tms.org.

21-26 10th Intl. Conf. on Surface Modification of Metals by Ion Implantation, *Gatlinburg, TN.* SMMIB-97, Attn.: V. Barnes, Oak Ridge Natl. Lab., Bldg. 3137, M.S. 6057, Oak Ridge, TN 37831-6057; e-mail smmib@ornl.gov.

21-26 Dynamical Properties of Solids, *Davos, Switzerland.* J. Hendekovic, European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-388-767135; fax 33-388-366987; e-mail euresco@esf.org; http://www.esf.org/euresco.

23 ▼ Defense Advanced Research Projects Agency 19th Systems and Technology Symposium, *Kansas City, MO.* R.C. Keleher, SatoTravel, 511 Shaw Rd. M/S.A, Sterling, VA 20166; 800-347-6338; fax 703-925-5773; e-mail bkeleher@satotravel.com; http://www.darpa.mil/darpatech.

23-26 1997 Ceramic Industry Manufacturing Conf., *Columbus, OH.* C. Hyland, Ceramic Industry, 5900 Harper Rd., Ste. 109, Solon, OH 44139; fax 216-498-9121; http://www.ceramics.com/ci.

23-28 Particle-Solid Interactions: Strong Perturbations, *San Sebastian, Spain.* J. Hendekovic, European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-388-767135; fax 33-388-366987; e-mail euresco@esf.org; http://www.esf.org/euresco.

28-1 Eastern Regional Conf. on Crystal Growth and Epitaxy, *Atlantic City, NJ.* R. Scripa, Univ. of Alabama at Birmingham, Dept. of Materials Engineering, 1150 10th Ave. South, Birmingham, AL 35294-4461; 205-934-8453; fax 205-934-8485; e-mail rscripa@eng.uab.edu.

28-3 MRS'97 Scientific Basis for Nuclear Waste Management, Davos, Switzerland. NAGRA, V. Schatzmann, Hardstrasse 73, 5430 Wettingen, Switzerland; 41-56-437-12-53; fax 41-56-437-12-07; e-mail mrs97@nagra.ch. **MRS.**

29-30 Annual Canadian Univ./Crown Labs/Industry Technology Transfer Conf., *Edmonton, Alberta, Canada.* L.W. Sircy, Technology Transfer Conferences, Inc., 325 Plus Park Blvd., #108, Nashville, TN 37217; 615-366-0679; fax 615-366-0695.

29-30 ▼ Micromachining and Microfabrication, *Austin, TX.* SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; http://www.spie.org.

29-1 2nd European Meeting on Integrated Ferroelectrics, *Jouy-en-Josas, Campus Thomson, France.* EMIF2 Secretariat, Groupe Francais de la Céramique, 47 à 73, Ave. Albert Thomas, 87065 Limoges Cedex, France; fax 33-5-55790998; e-mail jf.baumard@ensci.fr.

30-2 ▼ Advanced Metallization and Interconnect Systems for ULSI Applications, *San Diego, CA.* Continuing Education in Engineering, Univ. of California Extension, 1995 University Ave., M.C. 7010, Berkeley, CA 94720-7010; 510-642-4151; fax 510-642-6027; e-mail course@garnet.berkeley.edu.

OCTOBER 1997

1-2 ▼ Microelectronic Manufacturing, *Austin, TX.* SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; http://www.spie.org.

1-2 OEM Electronics Conf., *Boston, MA.* D. Wattersdorf, Exposition Excellence Corp., 112 Main St., Norwalk, CT 06851; 203-847-9599; fax 203-854-9438.

5-8 16th North American Conf. on Molecular Beam Epitaxy, *Ann Arbor, MI.* P. Bhattacharya, Conf. Chair, Univ. of Michigan, Dept. of EE&CS, 1301 Beal Ave., Ann Arbor, MI 48109; 313-763-6678; e-mail pkb@eecs.umich.edu.

5-8 Julian Szekely Memorial Symposium on Materials Processing, *Cambridge, MA.* TMS Customer Service Dept., 420 Commonwealth Dr., Warrendale, PA 15086; 412-766-9000; fax 412-776-3770; e-mail csc@tms.org.

6-8 12th Annual Technical Conf. of the American Society for Composites, *Dearborn, MI.* A. Duffer, Conf. Secretary, Mechanical Engineering Dept., Wayne State Univ., Detroit, MI 48202; 313-577-3877; fax 313-577-8789; e-mail gnewaz@eng.wayne.edu.

6-9 ▼ IEEE Intl. Silicon-on-Insulator Conf., *Yosemite, CA.* S. Grawet, All About Meetings, Inc.; 310-316-5153; fax 310-316-0713; e-mail 70541.1225@compuserve.com.

6-9 ▼ Intl. Rubber Conf., *Kuala Lumpur, Malaysia.* Secretary IRC'97 Malaysia, Rubber Research Inst. of Malaysia, P.O. Box 10150, 50908 Kuala Lumpur, Malaysia; 603-456-4516; fax 603-457-3512; e-mail drong@pop.jaring.my.

6-10 ▼ 8th Workshop on RF Superconductivity, *Padova, Italy.* V. Palmieri, Chairman, 8th Workshop on RF Superconductivity, INFN LNL Via Romea 4, Legnaro (Padua), Italy; fax 39-49-641925; e-mail abano@lnl.infn.it.

6-10 11th Intl. Conf. on Photopolymers and Intl. Conf. on Polyimides and Other Low K Dielectrics, *McAfee, NJ.* M.M. Khojasteh, IBM Corp., Microelectronics Div., 8/300-40E, 1580 Rt. 52, Hopewell Junction, NY 12533; 914-894-5458; fax 914-892-6256; e-mail mkhjqasteh@vnet.ibm.com.

8 Intl. Symposium on Solar Chemistry, *Villigen, Switzerland.* T. Daum, Secretariat, Solar Chemistry Symposium, Paul Scherrer Inst., CH-5232 Villigen PSI, Switzerland; 41-56-3102896; fax 41-56-3102199; e-mail cdaum@psi.ch.

11-17 OSA Annual Meeting, *Long Beach, CA.* Meetings Dept., Optical Society of America, 2010 Massachusetts Ave. NW, Washington, DC 20036-1023; 202-223-0920; fax 202-416-6100.

12-15 49th Pacific Coast Regional Meeting and American Ceramic Society Basic Science Division Meeting, *San Francisco, CA.* Customer Service Dept., American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail customersrv@acers.org.

12-16 30th Intl. Symposium on Microelectronics, *Philadelphia, PA.* ISHM'97/Intl. Microelectronics and Packaging Society, 1850 Centennial Park Dr., Ste. 105, Reston, VA 20191-1517; 703-758-1060; 703-758-1066; e-mail IMAPS@aol.com.

13-15 5th Intl. Symposium on Brittle Matrix Composites, *Warsaw, Poland.* A.M. Brandt, IFTR, Swietokrzyska 21, 00-049 Warsaw, Poland; fax 48-22-269815; e-mail abrandt@ippt.gov.pl.

14-16 ACerS Electronics Div. Meeting with the Intl. Microelectronics and Packaging Society, *Philadelphia, PA.* Customer Service Dept., American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail customersrv@acers.org; http://www.acers.org.

14-17 ▼ Intelligent Systems and Advanced Manufacturing, *Pittsburgh, PA.* SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; http://www.spie.org.

14-18 Radioactive Waste, Storage, Transportation, Recycling: Environment and Human Impact, *St. Petersburg, Russia.* Shpalernaja str. 49, 193015 St. Petersburg, Russia; 7-812-274-3796; fax 7-812-274-1707; e-mail kkv@prometey2.spb.su. **R-MRS, E-MRS.**

15-16 ▼ Quality Issues Conf., *Pittsburgh, PA.* H.G. Nowicki, Professional Analytical and Consulting Services, Inc., 409 Meade Dr., Coraopolis, PA 15108; 412-457-6576; fax 412-457-1214; e-mail hnpacs@aol.com; http://members.aol.com/hnpacs/pacs/htm.

20-24 ▼ 1997 Fall Conf. and Quality Testing Show, *Pittsburgh, PA.* American Society for Nondestructive Testing, Inc., 1711 Arlington Lane, P.O. Box 28518, Columbus, OH 43228-0518; 800-222-2768 or 614-274-6003; fax 614-274-6899; http://www.asnt.org.

20-24 15th Intl. Conf. on Magnet Technology, *Beijing, China.* L. Lin, MT-15 Program Committee, Applied Superconductivity Div., Inst. of Electrical Engineering, Chinese Academy of Sciences, P.O. Box 2703, Beijing 100080, P.R. China; 86-10-6256-1492; fax 86-10-6256-0904; e-mail asd@piano.iee.ac.cn.

20-24 44th American Vacuum Society National Symposium, *San Jose, CA.* A. Mulligan, American Vacuum Society, 120 Wall St., 32nd Floor, New York, NY 10005; 212-248-0200; fax 212-248-0245; e-mail angela@vacuum.org; http://www.vacuum.org.

21-23 1997 U.S. Workshop on Physics and Chemistry of II-VI Materials, *Santa Barbara, CA.* M. Goldfarb, 1997 II-VI Workshop, Palisades Inst. for Research Services, Inc., 201 Varick St., Ste. 1006, New York, NY 10014; 703-413-3891; fax 703-413-1315; e-mail mgoldfar@washington.palisades.org.

21-23 Medical Equipment Design and Technology Conf., *Amsterdam, The Netherlands.* Canon Communications, Inc., 3340 Ocean Park Blvd., Ste. 1000, Santa Monica, CA 90405-3216; 310-392-5509; fax 310-392-1557; http://www.cancom.com.

24-31 American Ceramic Society Glass and Optical Materials Division Joint Meeting with the Optical Society of America, *Williamsburg, VA.* Customer Service Dept., American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail customersrv@acers.org.

27-30 ▼ 10th Intl. Symposium on Superconductivity, *Gifu, Japan.* ISS'97 Secretariat, ISTEK, Eishin Kaihatsu Bldg. 6F, 34-3 Shimbashi 5-chome, Minato-ku, Tokyo 105, Japan; 81-3-3431-4002; fax 81-3-3431-4044.

27-31 2nd Intl. Conf. on Nitride Semiconductors, *Tokushima, Japan*. S. Yoshida, ICNS'97, Materials Science Div., Electrotechnical Lab., 1-1-4 Umezono, Tsukuba, Ibaraki 305, Japan; 81-298-54-5222; fax 81-298-58-5434; e-mail syoshida@etl.go.jp; <http://www-icns.ee.tokushima-u.ac.jp>.

27-31 23rd Intl. Symposium for Testing and Failure Analysis, *Santa Clara, CA*. ASM Intl., Member Services Center, Materials Park, OH 44073-0002; 216-338-5151; fax 216-338-4634; e-mail memserv@po.asm-intl.org.

27-31 Joint Magneto-Optical Recording Intl. Symposium and Intl. Symposium on Optical Memory, *Yamagata, Japan*. Secretariat for the Joint MORIS/ISOM '97, c/o Business Center for Academic Societies Japan, 5-16-9 Honkomagome, Bunkyo-ku, Tokyo 113, Japan; 81-3-5814-5800; fax 81-3-5814-5823.

28-30 1st Intl. Symposium on Nuclear and Related Techniques in Agriculture, Industry, Health, and Environment and 3rd Workshop on Nuclear Physics, *Havana, Cuba*. L. Desdin, Ctr. de Estudios Aplicados al Desarrollo Nuclear, P.O. Box 6122, Habana, Cuba; 537-221518; fax 537-221518; e-mail root@ceaden.cigb.edu.cu.

29-1 Annual Convention of the Composites Fabricators Association and the Society for the Advancement of Material and Process Engineering, *Orlando, FL*. M. Henriksen, COMPOSITES 97, Composites Fabricators Association, 8201 Greensboro Dr., Ste. 300, McLean, VA 22102; 703-610-9025; fax 703-610-9005; e-mail cfa.info@cfa.hq.org.

NOVEMBER 1997

4-8 Unified Intl. Technical Conf. on Refractories, *New Orleans, LA*. Jerry E. Elliott, The American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5866; fax 614-899-6109; e-mail elliott@acers.org.

9-11 Workshop on Tribology Issues and Opportunities in Micro Electro Mechanical Systems, *Columbus, OH*. B. Bhushan, Dept. of Mechanical Engineering, Ohio State Univ., Columbus, OH 43210-1107; 614-292-0651; fax 614-292-0325; e-mail bhushan.2@osu.edu.

16-19 1997 Intl. Conf. on Tungsten, Refractory Metals, and Alloys, *Orlando, FL*. Metal Powder Industries Federation, 105 College Rd. East, Princeton, NJ 08540; 609-452-7700; fax 609-987-8523; e-mail info@mpif.org.

16-21 1997 Congress of the American Society of Mechanical Engineers, *Dallas, TX*. G.J. Wiens, Program Chair, Dept. of Mechanical Engineering, 237 MEB, Univ. of Florida, Gainesville, FL 32611-6300; 904-392-0806; fax 904-392-1071, e-mail gwiens@cimar.me.ufl.edu.

16-21 AICHE Annual Meeting, *Los Angeles, CA*. American Inst. of Chemical Engineers, 345 E. 47th St., New York, NY 10017-2395; 1-800-242-4363; <http://www.aische.org/meeting/1997/annual>.

17-18 Midwest Univ. Industry Technology Transfer Conf., *Chicago, IL*. L.W. Sircy, Technology Transfer Conferences, Inc., 325 Plus Park Blvd., #108, Nashville, TN 37217; 615-366-0679; fax 615-366-0695.

17-20 16th Intl. Congress on Applications of Lasers and Electro-Optics, *San Diego, CA*. D. Flynn, Conf. Coordinator, Laser Inst. of America, 12424 Research Pkwy., Ste. 125, Orlando, FL 32826; 407-380-1553; fax 407-380-5588.

DECEMBER 1997

1-5 MRS Fall Meeting, *Boston, MA*. Materials Research Society, 9800 McKnight Rd., Pittsburgh, PA 15237-6006; 412-367-3003; fax 412-367-4373; <http://www.mrs.org>. MRS.

16-20 9th Intl. Workshop on Physics of Semiconductor Devices, *Delhi, India*. S.K. Agarwal, Secretary, IWPSD-97, Solid State Physics Lab., Lucknow Rd., Timarpur, Delhi-110054, India; 91-11-238739; fax 91-11-2913609; e-mail ska@drsspl.ren.nic.in.

JANUARY 1998

6-9 7th Joint MMM-Intermag Magnetism Conf., *San Francisco, CA*. D. Suiters, Conf. Coordinator, 655 15th St. N.W., Ste. 300, Washington, DC 20005; 202-639-5088; fax 202-347-6109; e-mail magnetism@courtesy.assoc.com.

FEBRUARY 1998

15-19 127th TMS Annual Meeting, *San Antonio, TX*. Customer Service Dept., TMS, 420 Commonwealth Dr., Warrendale, PA 15086; 412-776-9000; fax 412-776-3770; e-mail csc@tms.org; <http://www.tms.org/meetings/meeting.html>.

23-26 SAE Intl. Congress, *Detroit, MI*. Meetings & Exhibits Dept., Society of Automotive Engineers, 400 Commonwealth Dr., Warrendale, PA 15096-0001; 412-776-4841; fax 412-776-1830; e-mail tim@sae.org.

MARCH 1998

23-27 9th Asia-Pacific Conf. on Nondestructive Testing, Spring Conf., and 7th Annual Research Symposium, *Anaheim, CA*. American Society for Nondestructive Testing, Inc., 1711 Arlington Lane, P.O. Box 28518, Columbus, OH 43228-0518; 800-222-2768 or 614-274-6003; fax 614-274-6899; <http://www.asnt.org>.

APRIL 1998

13-17 MRS Spring Meeting, *San Francisco, CA*. Materials Research Society, 9800 McKnight Road, Pittsburgh, PA 15237-6006; 412-367-3003; fax 412-367-4373; <http://www.mrs.org>. MRS.

20-25 7th Conf. on Frontiers of Electron Microscopy in Materials Science, *Irsee, Germany*. Kloster Irsee, Schwaebisches Tagungs- und Bildungszentrum, Klosterring 4, 87660 Irsee, Germany; 49-8341-906-00; fax 49-8341-742-78.

26-1 44th Annual Technical Meeting of the Inst. of Environmental Sciences, *Phoenix, AZ*. Inst. of Environmental Sciences, 940 E. Northwest Hwy., Mt. Prospect, IL 60056; 847-255-1561; 847-255-1699; e-mail istenvsci@aol.com.

26-1 Nonstoichiometric Ceramics and Intermetallics, *Kona, HI*. Engineering Foundation, 345 E. 47th St., New York, NY 10017; 212-705-7836; fax 212-705-7441; e-mail engfnd@aol.com; <http://www.engfnd.org>.

JUNE 1998

1-5 6th Intl. Symposium on Acoustic Emission from Composite Materials, *San Antonio, TX*. American Society for Nondestructive Testing, Inc., 1711 Arlington Lane, P.O. Box 28518, Columbus, OH 43228-0518; 800-222-2768 or 614-274-6003; fax 614-274-6899; <http://www.asnt.org>.

14-19 9th World Ceramics Congress and Forum on New Materials, *Florence, Italy*. CIMTEC '98, P.O. Box 174, 48018 Faenza, Italy; 39-546-663362; fax 39-546-664138; <http://www.dinamica.it/cimtec>.

JULY 1998

5-10 Advances in Cement and Concrete, *Banff, Alberta, Canada*. Engineering Foundation, 345 E. 47th St., New York, NY 10017; 212-705-7836; fax 212-705-7441; e-mail engfnd@aol.com; <http://www.engfnd.org>.

7-9 Micro 98, Hammersmith, *London, UK*. Royal Microscopical Society, 37/38 St. Clements, Oxford OX4 1AJ, UK; 44-1-865-248768; 44-1-865-791237; e-mail meetings@rms.org.uk; <http://www.rms.org.uk>.

12-16 3rd Pacific Rim Intl. Conf. on Advanced Materials and Processing, *Honolulu, HI*. P. Weiss, PRICM 3 Program Coordinator, TMS, 420 Commonwealth Dr., Warrendale, PA 15086-7514; 412-776-9000, ext. 227; fax 412-776-3770; e-mail weiss@tms.org.

AUGUST 1998

24-27 Electroceramics VI, 11th Intl. Symposium on Applications of Ferroelectrics, and 4th European Conf. on Applications of Polar Dielectrics, *Montreux, Switzerland*. ECAPD & ISAF, Electroceramics VI, LC-DMX-EPFL, CH-1015 Lausanne, Switzerland; e-mail electro@lc.dmx.epfl.ch; <http://dmxwww.epfl.ch/lc/electro/home.html>.

26-31 12th Intl. Conf. on Crystal Growth, *Jerusalem, Israel*. ICCG 12, c/o Intl. Travel & Congresses Ltd., P.O. Box 29313, Tel Aviv 61292, Israel; 972-3-5102538; fax 972-3-510604.

SEPTEMBER 1998

13-18 Applied Superconductivity Conf., Palm Desert, CA. Centennial Conferences, 303-499-2299; fax 303-499-2599; e-mail centennial@orci.com.

15-19 4th Intl. Conf. on Computer Simulation of Radiation Effects in Solids, *Okayama, Japan*. Y. Yamamura, Okayama Univ. of Science, Ridai-cho, Okayama 700, Japan; 81-86-252-3161; fax 81-86-255-7700; e-mail yama@dap11.ous.ac.jp.

OCTOBER 1998

19-23 Fall Conf. and Quality Testing Show, *Nashville, TN*. American Society for Nondestructive Testing, Inc., 1711 Arlington Lane, P.O. Box 28518, Columbus, OH 43228-0518; 800-222-2768 or 614-274-6003; fax 614-274-6899; <http://www.asnt.org>.

25-30 Intl. Rare Earths Conf., *Fremantle, Western Australia*. Secretariat, Materials Inst. of Western Australia, 133 Salvado Rd., Wembley, Western Australia 6014; 61-9-387-9590; fax 61-9-383-9639; e-mail RE98@miwa.org.au; <http://www.miwa.org.au/IREC98>.

26-29 5th Intl. Symposium on Functionally Graded Materials, *Dresden, Germany*. FGM 09 Secretariat, Conf. Svc., TU Dresden GmbH, Lufthansa City Ctr., Frau Deckert/Frau Wolf, Georg Baehr Strasse 8, 01069 Dresden, Germany; or K.J. Bowman, Purdue Univ., West Lafayette, IN 47907; 765-494-4096.

30 Intl. Rare Earths Conf., *Fremantle, Western Australia*. Erica Jago, Rare Earths '98, c/o Materials Institute of Western Australia, 133 Salvador Road, Wembley, Western Australia 6014; 61-9-387-9590; fax 61-9-383-9639; e-mail RE98@miwa.org.au; <http://www.miwa.org.au/IREC98>.

30-4 MRS Fall Meeting, *Boston, MA*. Materials Research Society, 9800 McKnight Road, Pittsburgh, PA 15237-6006; 412-367-3003; fax 412-367-4373; <http://www.mrs.org>. MRS.

DECEMBER 1998

8-11 2nd Asian Meeting on Ferroelectrics, Intl., *Singapore*. AMF-2 Secretariat, CCE, Nanyang Tech. Univ., Singapore 639798; 65-799-4723; fax 65-793-0997; e-mail amf2@ntu.edu.sg. □